



Transceiver Signal Integrity Development Kit, Stratix IV GX Edition Reference Manual



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Document Version: 1.0
Document Date: February 2009

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Introduction

The Transceiver Signal Integrity Development Kit, Stratix® IV GX Edition allows you to evaluate the performance the Stratix IV GX transceivers and the low power benefits of the device itself. This document provides the detailed pin-out and component reference information required to create FPGA designs for implementation on the development board.



For information about setting up the Stratix IV GX transceiver signal integrity development board, and using the included software, refer to the *Transceiver Signal Integrity Development Kit, Stratix IV GX Edition Getting Started User Guide*.

General Description

The Stratix IV GX transceiver signal integrity development board provides a hardware platform for evaluating the performance and signal integrity features of the Altera® Stratix IV GX devices. The board features the following major component blocks:

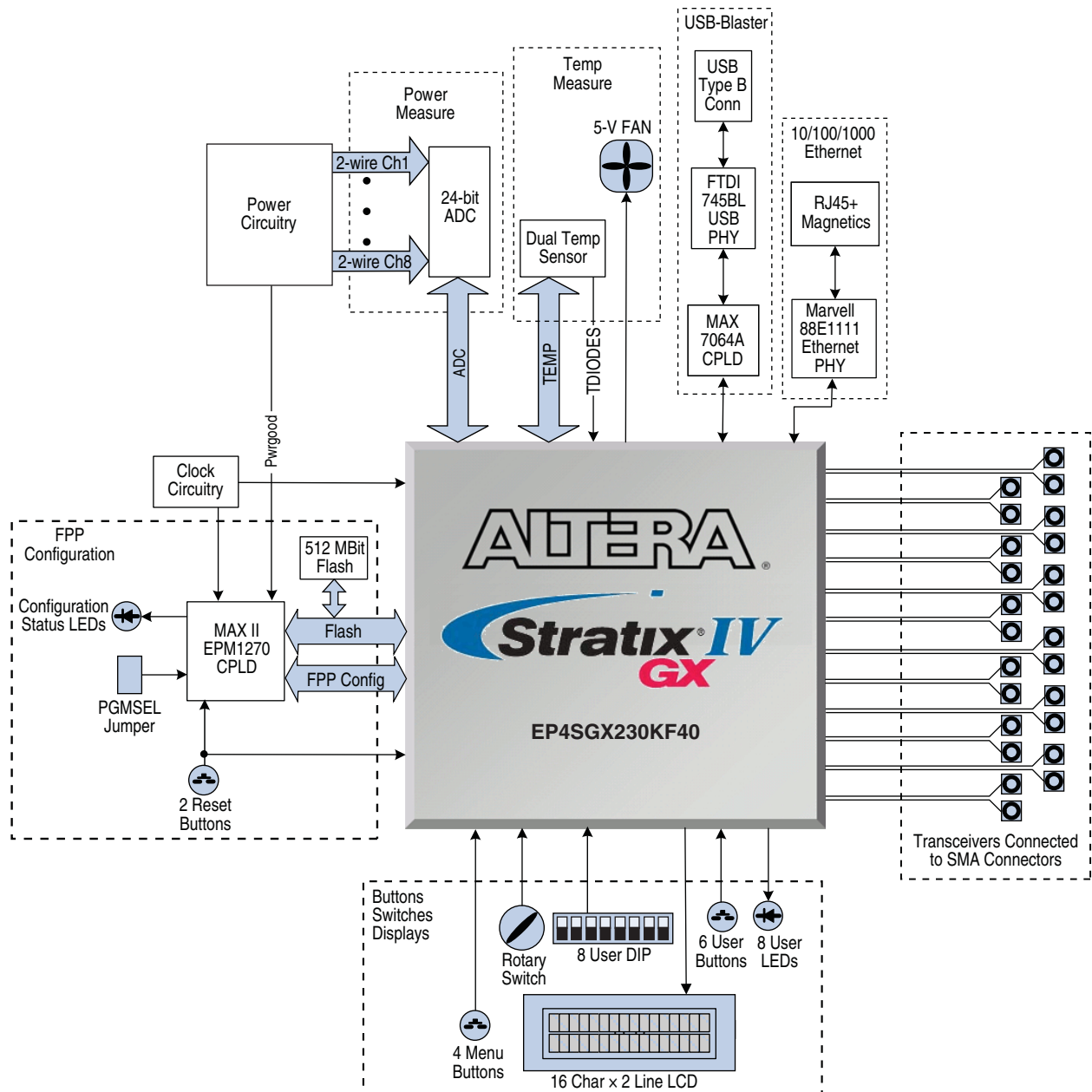
- EP4SGX230KF40 FPGA
 - 0.9-V core
 - 1517-pin Fineline BGA (FBGA)
- FPGA Configuration
 - MAX® II+Flash Fast Passive Parallel (FPP) configuration
 - Flash storage for two configuration images (factory and user)
 - On-board USB-Blaster™ using the Quartus® II Programmer
 - JTAG header for external USB-Blaster with the Quartus II Programmer

- Status and Setup Elements
 - System reset push-button
 - CPU reset push-button
 - 4-position spread spectrum clock selection DIP switch
 - Three configuration status LEDs (factory, user, error)
 - USB-Blaster activity LED
 - Ethernet link 10 LED
 - Ethernet link 100 LED
 - Ethernet link 1000 LED
 - Ethernet full duplex LED
 - Ethernet TX activity LED
 - Ethernet RX activity LED
 - Over-temperature warning LED
 - Power LED
- FPGA Clock Sources
 - FPGA Core Clock Sources
 - 25-MHz/100-MHz/125-MHz/200-MHz selectable spread spectrum clock oscillator
 - 50-MHz clock oscillator
 - SMA connectors for external differential clock input
 - FPGA Transceiver Clock Sources
 - 100-MHz clock oscillator
 - Socketed clock oscillator
 - 156.25-MHz clock oscillator
 - SMA connectors for external differential clock input
- Clock Outputs and Triggers
 - Two FPGA I/O clock outputs to SMA connectors
 - 100-MHz clock trigger output to SMA connector
 - Socketed clock trigger output to SMA connector
 - 156.25-MHz clock trigger output to SMA connector

- General User Input/Output
 - 8-position user DIP switch
 - Six user push-buttons
 - Four directional LCD menu push-buttons
 - Hex rotary switch
 - Eight user LEDs
 - 16 character × 2 line LCD
- Components and Interfaces
 - 10/100/1000 Ethernet PHY and RJ-45 Jack
 - Transceiver Channels
 - Six full-duplex transceiver channels from the same transceiver block brought out to SMA connectors using stripline routing
 - One full-duplex transceiver channel brought out to SMA connectors using microstrip routing
 - One channel brought out to SMAs with microstrip routing with 33 in. board trace length on transmit and 7 in. board trace length on receive to simulate the degradation associated with backplanes or long traces
- Power
 - 14-V – 20-V DC input
 - 2.5-mm Barrel Jack for DC power input
 - On/Off slide power switch
 - On-board power measurement circuitry
- Heat Sink and Fan
 - 40-mm heat sink and 5-V DC fan combo

Development Board Block Diagram

Figure 1–1 shows the block diagram of the Stratix IV GX transceiver signal integrity board.

Figure 1-1. Stratix IV GX Transceiver Signal Integrity Board Block Diagram

Handling the Board

When handling the board, it is important to observe the following precaution:



Static Discharge Precaution: Without proper anti-static handling, the board can be damaged. Therefore, use anti-static handling precautions when touching the board.

The Stratix IV GX transceiver signal integrity board must be stored between -40°C and 100°C . The recommended operating temperature is between 0°C and 55°C .

Introduction

This chapter introduces all the important components on the Stratix IV GX transceiver signal integrity development board. [Figure 2-1](#) illustrates major component locations and [Table 2-1](#) provides a brief description of all features of the board.



A complete set of schematics, a physical layout database, and GERBER files for the development board reside in the Stratix IV GX transceiver signal integrity development kit installation directory.



For information about powering up the board and installing the development kit software, refer to the *Transceiver Signal Integrity Development Kit, Stratix IV GX Edition Getting Started User Guide*.

This chapter consists of the following sections:

- “Board Overview”
- “Featured Device: Stratix IV GX Device” on page 2-6
- “Configuration, Status, and Setup Elements” on page 2-9
- “General User Input/Output” on page 2-16
- “Flash Memory Device” on page 2-19
- “Components and Interfaces” on page 2-21
- “Power” on page 2-26

Board Overview

This section provides an overview of the Stratix IV GX transceiver signal integrity development board, including an annotated board image and component descriptions. [Figure 2-1](#) provides an overview of the board features.

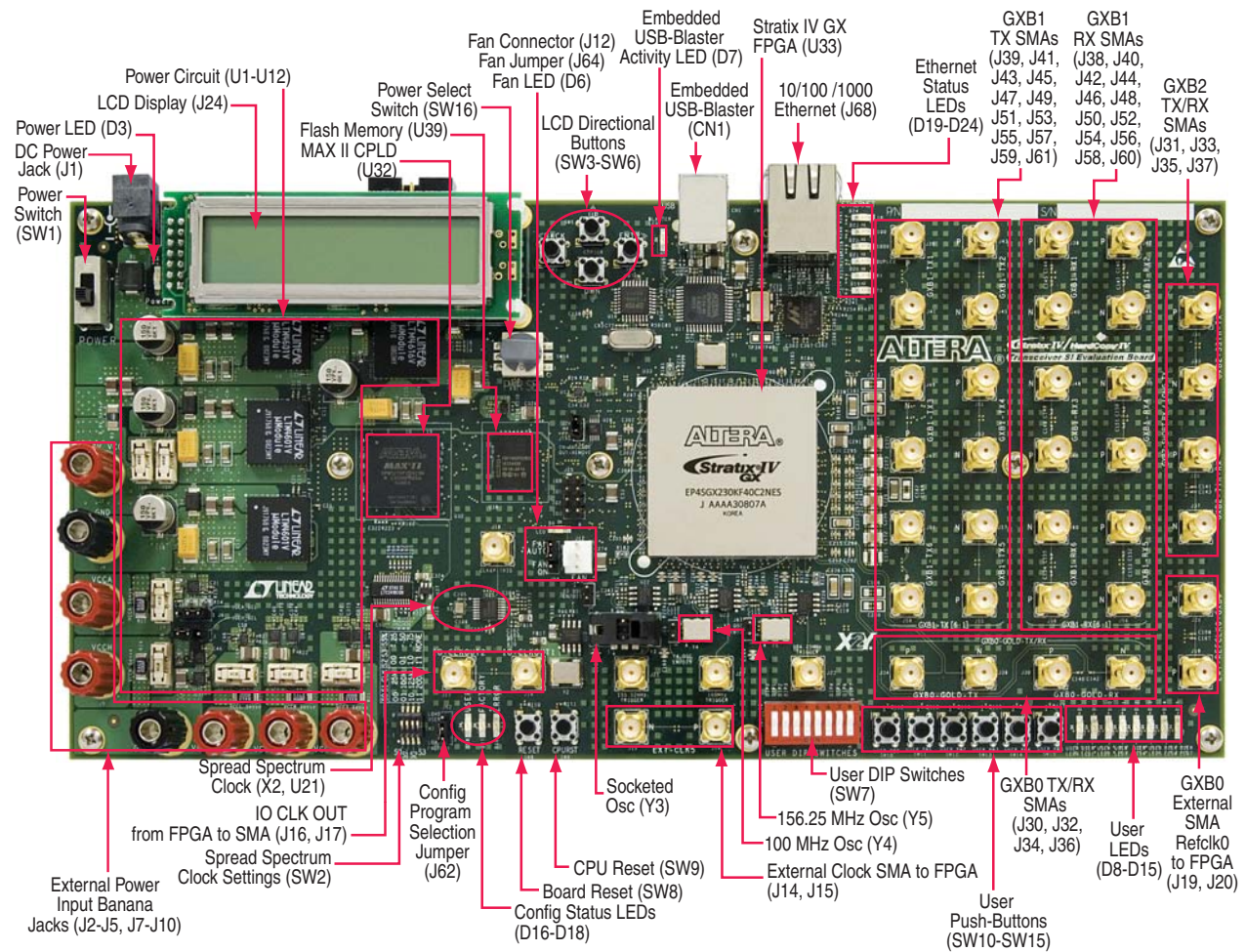
Figure 2-1. Overview of the Stratix IV GX Transceiver Signal Integrity Board Features

Table 2-1 describes the components and lists their corresponding board references.

Table 2-1. Stratix IV GX Transceiver Signal Integrity Development Board Components (Part 1 of 4)

Board Reference	Type	Description
Featured Devices		
U33	EP4SGX230KF40	Stratix IV GX device in a 1517-pin FBGA package.
Configuration, Status, and Setup Elements		
J28	JTAG programming header	JTAG programming header for connecting an Altera USB-Blaster dongle to program the FPGA and MAX II CPLD devices.
J26	MAX II JTAG configuration jumper	Jumper to bypass the MAX II CPLD from the JTAG programming chain.
J63	JTAG for embedded USB-Blaster MAX II CPLD	JTAG for embedded USB-Blaster MAX II CPLD device programming.
U32	MAX II CPLD	Altera EPM1270256C3N, MAX II 256-pin CPLD for MAX II+Flash FPP configuration.

Table 2-1. Stratix IV GX Transceiver Signal Integrity Development Board Components (Part 2 of 4)

Board Reference	Type	Description
D6	Fan LED	Indicates an FPGA over-temperature condition exists and a fan should be attached to the FPGA and running.
D16–D18	Configuration status LEDs	LEDs to indicate the status of Fast Passive Parallel (FPP) configuration.
J62	Configuration program select jumper	Jumper to select the flash configuration image to load upon power-on or reset.
J65	Socketed Y3 OSC enable/disable jumper	Jumper to enable or disable the Y3 OSC.
J66	Y4 OSC enable/disable jumper	Jumper to enable or disable the Y4 OSC.
J67	Y5 OSC enable/disable jumper	Jumper to enable or disable the Y5 OSC.
D3	Power LED	Blue LED indicates board power status.
D7	USB-Blaster LED	Green activity status LED for embedded USB-Blaster.
D19–D24	Bank of Ethernet LINK and Status LEDs	Ethernet Link, Speed, Full Duplex, Transmit and Receive activity LEDs.
J6	VCCA voltage selection jumper	This jumper selects the V_{CCA} voltage to the FPGA.
J11	VCCH voltage selection jumper	This jumper selects the V_{CCH} voltage to the FPGA.
SW16	Power measurement rotary switch	This switch selects 1 of 6 measured FPGA power rails to display on the LCD.
SW2	Spread spectrum configuration DIP switch	DIP switch to set the spread spectrum output clock frequency and down-spread percentages.
J18	Spread spectrum clock trigger	Spread spectrum clock source routed to SMA for triggering purposes.
J21	Y3 OSC clock trigger	Y3 oscillator clock source routed to SMA for triggering purposes.
J22	Y4 OSC clock trigger	Y4 oscillator clock source routed to SMA for triggering purposes.
J23	Y5 OSC clock trigger	Y5 oscillator clock source routed to SMA for triggering purposes.
J14, J15	Differential SMA clock input to FPGA core	SMA for receiving a differential external clock input to the FPGA core.
J19, J20	Differential SMA clock input to FPGA transceiver	SMA for receiving a differential external clock input to the FPGA transceiver.
J16, J17	Differential SMA clock output from FPGA core	SMA for sending a differential clock output from the FPGA core.
Clock Circuitry		
Y2, U20	50-MHz OSC and clock buffer	50-MHz clock to FPGA and MAX II CPLD.
Y3, U22	Socketed OSC and clock buffer	5×7-mm oscillator socket for installing alternate oscillator frequencies to the FPGA transceivers.
Y4, U23	100-MHz OSC and clock buffer	100-MHz clock to FPGA transceivers.
Y5, U24	156.25-MHz OSC and clock buffer	156.25-MHz clock to FPGA transceivers.
X1	6-MHz XTAL	XTAL for FTDI USB PHY Device.
Y1	24-MHz OSC	24-MHz oscillator for embedded USB-Blaster MAX II CPLD.
X3	25-MHz OSC	25-MHz oscillator for Marvell 88E1111 Ethernet PHY device.
X2, U21	25-MHz OSC and spread spectrum clock buffer	25-MHz oscillator and spread spectrum clock buffer circuitry.

Table 2-1. Stratix IV GX Transceiver Signal Integrity Development Board Components (Part 3 of 4)

Board Reference	Type	Description
General User Input and Output		
SW7	Bank of 8 user DIP switches	User DIP switches.
SW10–SW15	Bank of 6 user push-buttons	User push-buttons switches.
D8–D15	Bank of 8 user LEDs	User LEDs.
SW3–SW6	LCD control push-buttons	Up, Down, Back, and Enter push-buttons for implementing user LCD menu/control.
J25	General purpose user I/O header field	Four user I/Os brought out to a 0.1 in. header field.
J24	LCD interface header	Header for interfacing a 16 character × 2 line LCD.
Memory Devices		
U39	Flash Memory	Numonyx 48F4400P0VB00, 512-Mbit Flash Memory.
Components and Interfaces		
CN1	USB Type-B connector	USB interface for embedded USB-Blaster.
U17	MAX II CPLD	Altera EPM7064AETC44 MAX II CPLD device for embedded USB-Blaster circuitry.
J68	Ethernet RJ45 jack	Halo HFJ11-1G02E RJ45 Ethernet jack with integrated magnetic.
U40	10/100/1000 Ethernet PHY	Marvell 88E1111 triple speed Ethernet PHY.
J34, J36	GXB0 transmit channel 0	Transceiver GXB0 transmit channel 0 connected to SMA.
J30, J32	GXB0 receive channel 0	Transceiver GXB0 receive channel 0 connected to SMA.
J39, J41	GXB1 transmit channel 1	Transceiver GXB1 transmit channel 1 connected to SMA.
J43, J45	GXB1 transmit channel 2	Transceiver GXB1 transmit channel 2 connected to SMA.
J55, J57	GXB1 transmit channel 3	Transceiver GXB1 transmit channel 3 connected to SMA.
J59, J61	GXB1 transmit channel 4	Transceiver GXB1 transmit channel 4 connected to SMA.
J47, J49	GXB1 transmit channel 5	Transceiver GXB1 transmit channel 5 connected to SMA.
J51, J53	GXB1 transmit channel 6	Transceiver GXB1 transmit channel 6 connected to SMA.
J38, J40	GXB1 receive channel 1	Transceiver GXB1 receive channel 1 connected to SMA.
J42, J44	GXB1 receive channel 2	Transceiver GXB1 receive channel 2 connected to SMA.
J54, J56	GXB1 receive channel 3	Transceiver GXB1 receive channel 3 connected to SMA.
J58, J60	GXB1 receive channel 4	Transceiver GXB1 receive channel 4 connected to SMA.
J46, J48	GXB1 receive channel 5	Transceiver GXB1 receive channel 5 connected to SMA.
J50, J52	GXB1 receive channel 6	Transceiver GXB1 receive channel 6 connected to SMA.
J31, J33	GXB2 transmit channel 7	Transceiver GXB2 transmit channel 7 connected to SMA.
J35, J37	GXB2 receive channel 7	Transceiver GXB2 receive channel 7 connected to SMA.
J12	Fan power connector	Power connector for 5-V DC fan sink.
J64	Fan control jumper	Jumper to select whether the fan is always on or automatically controlled by the FPGA.
SW8	Reset push-button	Board reset push-button.
SW9	CPU reset push-button	CPU reset push-button.

Table 2-1. Stratix IV GX Transceiver Signal Integrity Development Board Components (Part 4 of 4)

Board Reference	Type	Description
Power		
J1	Power Input Jack	14-V – 20-V DC female input power jack. Accepts 2.5-mm male center-positive barrel from supplied 16-V DC power supply.
SW1	Power switch	Switch to power on/off the board.
J2	0.9-V banana jack	Banana jack for supplying external 0.9-V V_{CC} power to the FPGA. Fuses F1 and F2 must be removed prior to supplying external power to this banana jack.
J3	VCCA banana jack	Banana jack for supplying external V_{CCA} power to the FPGA. Fuse F3 must be removed prior to supplying external power to this banana jack.
J7	VCCR banana jack	Banana jack for supplying external V_{CCR} power to the FPGA. Fuse F4 must be removed prior to supplying external power to this banana jack.
J8	VCCT banana jack	Banana jack for supplying external V_{CCT} power to the FPGA. Fuse F5 must be removed prior to supplying external power to this banana jack.
J9	VCCH banana jack	Banana jack for supplying external V_{CCH} power to the FPGA. Fuse F6 must be removed prior to supplying external power to this banana jack.
J10	VCCL banana jack	Banana jack for supplying external V_{CCL} power to the FPGA. Fuse F7 must be removed prior to supplying external power to this banana jack.
J4, J5	GND banana jack	Banana jack connected to GND of the board.
F1, F2	10A fuse	Fuses for 0.9-V V_{CC} core of the FPGA. These fuses must be removed when an external power is applied to this banana jack.
F3	2A fuse	Fuse for V_{CCA} power of the FPGA. This fuse must be removed when an external power is applied to this banana jack.
F6	5A fuse	Fuse for V_{CCH} power of the FPGA. This fuse must be removed when an external power is applied to this banana jack.
F7	2A fuse	Fuse for V_{CCL} power of the FPGA. This fuse must be removed when an external power is applied to this banana jack.
F4	2A fuse	Fuse for V_{CCR} power of the FPGA. This fuse must be removed when an external power is applied to this banana jack.
F5	2A fuse	Fuse for V_{CCT} power of the FPGA. This fuse must be removed when an external power is applied to this banana jack.
U14	Power measurement ADC	Linear Technology LTC2418CGN 24-bit delta-sigma analog to digital converter (ADC).
R3	0.001- Ω Rsense	Sense resistor for measuring FPGA V_{CC} core power.
R11	0.009- Ω Rsense	Sense resistor for measuring FPGA V_{CCA} power.
R24	0.009- Ω Rsense	Sense resistor for measuring FPGA V_{CCH} power.
R25	0.009- Ω Rsense	Sense resistor for measuring FPGA V_{CCL} power.
R20	0.009- Ω Rsense	Sense resistor for measuring FPGA V_{CCR} power.
R21	0.009- Ω Rsense	Sense resistor for measuring FPGA V_{CCT} power.

Featured Device: Stratix IV GX Device

The Stratix IV GX transceiver signal integrity development board features the EP4SGX230KF40 Stratix IV FPGA device (U33) in a 1517-pin FBGA package.


 For more information about Stratix IV GX devices, refer to the *Stratix IV Device Handbook*.

Table 2-2 describes the features of the Stratix IV GX EP4SGX230KF40 device.

Table 2-2. Stratix IV GX Device EP4SGX230KF40 Features

ALMs	Equivalent LEs	M9K RAM Blocks	M144K Blocks	Total RAM bits	DSP Blocks	18-bit × 18-bit Multipliers	PLLs	Maximum User I/O pins	Package Type
91,200	228,000	1,235	22	17,133	161	1,288	8	736	1517-pin FBGA

Table 2-3 lists the Stratix IV GX component reference and manufacturing information.

Table 2-3. Stratix IV GX Device Component Reference and Manufacturing Information

Board Reference	Description	Manufacturer	Manufacturing Part Number	Manufacturer Website
U33	Stratix IV GX	Altera Corporation	EP4SGX230KF40	www.altera.com

I/O Resources

Figure 2-2 shows the bank organization and I/O count for the EP4SGX230K device in the 1517-pin FBGA package.

Figure 2-2. Stratix IV GX Device I/O Bank Diagram

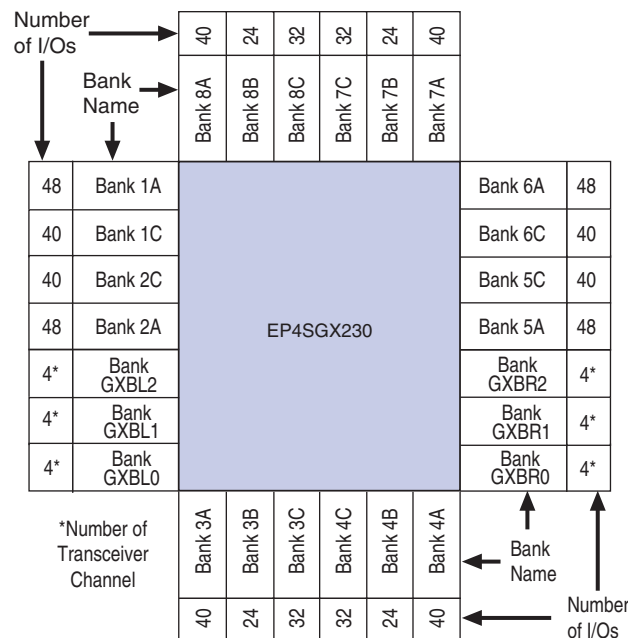


Table 2-4 summarizes the FPGA I/O usage by function on the Stratix IV GX transceiver signal integrity development board. I/O direction is with respect to the FPGA.

Table 2-4. Stratix IV GX I/O Usage Summary (Part 1 of 3)

Function	I/O Type	I/O Count	Description
FPGA Transceiver Clocks			
100-MHz Diff Clock	LVDS input	2	Diff REFCLK Input
Socketed Diff Clock	LVDS input	2	Diff REFCLK Input
156.25-MHz Diff Clock	LVDS input	2	Diff REFCLK Input
SMA Diff Clock Inputs	LVDS input	2	Diff REFCLK Input
FPGA Global Clocks			
50-MHz Clock	2.5V CMOS input	1	Global Clock Input
Spread Spectrum Clock	LVDS input	2	Diff Global Clock
SMA Diff Clock Input	LVDS input	2	Diff Global Clock
SMA Diff I/O or Clock Output	—	2	Diff Global I/O or Clock Output
Temperature Monitor			
Temp Sense Diodes	Analog	2	Stratix IV GX Internal Sense Diode
Power Measure			
ADC Interface	2.5V CMOS	5	8 Diff Channel 24-bit A/D Converter
Temp Measure			
MAX1619 Interface	2.5V CMOS	4	Die Temp Sense
EEPROM			
EEP_CS _n	2.5V CMOS output	1	EEPROM Chip Select
Fan			
FAN_On	2.5V CMOS output	1	Fan Control
FAN_LED	2.5V CMOS output	1	Fan LED
USB-Blaster			
JTAG USB-Blaster or JTAG header	2.5V CMOS	4	Built-in USB-Blaster or JTAG 0.1-mm header for Debug
FPP Configuration			
FPGA Dclk	2.5V CMOS input	1	FPP Dclk
FPGA D[7:0]	2.5V CMOS input	8	FPP Data
MSEL [2:0]	2.5V CMOS input	3	Dedicated Configuration Pins
NCONFIG	2.5V CMOS input	1	Dedicated Configuration Pins
NSTATUS	2.5V CMOS inout	1	Dedicated Configuration Pins
NCE	2.5V CMOS input	1	Dedicated Configuration Pins
CONFIG_DONE	2.5V CMOS inout	1	Dedicated Configuration Pins
INIT_DONE	2.5V CMOS output	1	Dedicated Configuration Pins
PGM[2:0]	2.5V CMOS output	3	Configuration Program Select Pins

Table 2-4. Stratix IV GX I/O Usage Summary (Part 2 of 3)

Function	I/O Type	I/O Count	Description
Flash Memory			
ADDR[25:0]	2.5V CMOS output	26	Flash Address Bus
DATA[15:0]	2.5V CMOS inout	16	Flash Data Bus
FLASH_CEn	2.5V CMOS output	1	Flash Chip Enable
FLASH_OEn	2.5V CMOS output	1	Flash Read Strobe
FLASH_WEn	2.5V CMOS output	1	Flash Write Strobe
FLASH_BSYn	2.5V CMOS input	1	Flash Busy
FLASH_CLK	2.5V CMOS output	1	Flash Clock
FLASH_RSTn	2.5V CMOS output	1	Flash Reset
FLASH_ADVn	2.5V CMOS output	1	Flash Address Valid
FLASH_WPn	2.5V CMOS output	1	Flash Write Protect
Resets			
CPU_RESETh	2.5V CMOS input	1	Nios® II CPU Reset
S4GX_RESETh	2.5V CMOS input	1	S4GX General FPGA Reset
Switches, Buttons, LEDs			
User Push-buttons	2.5V CMOS input	6	6 User Push-buttons
User DIP Switches	2.5V CMOS input	8	8 User DIP Switches
User LEDs	2.5V CMOS output	8	8 User LEDs (GREEN)
HEX Rotary Switch	2.5V CMOS input	4	16 Position Rotary Switch
Directional Menu Buttons	2.5V CMOS input	4	4 LCD Menu Buttons
User I/Os	2.5V CMOS inout	4	4 User I/O pins to header field
LCD			
16 Character × 2 Line LCD	2.5V CMOS	11	LCD
Ethernet			
TXD[3:0]	2.5V CMOS output	4	Ethernet Transmit RGMII Data Bus
TXEN	2.5V CMOS output	1	Ethernet Transmit Enable
GTCLK	2.5V CMOS output	1	Ethernet Transmit Clock
RXD[3:0]	2.5V CMOS input	4	Ethernet Receive RGMII Data Bus
RXDV	2.5V CMOS input	1	Receive Data Valid
RXCLK	2.5V CMOS input	1	Receive Clock
MDC	2.5V CMOS input	1	Ethernet MII Clock
MDIO	2.5V CMOS inout	1	Ethernet MII Data
ENET_SGMII_TXP/N	LVDS output	2	Ethernet SGMII Transmit Data Positive/Negative
ENET_SGMII_RXP/N	LVDS input	2	Ethernet SGMII Receive Data Positive/Negative
Transceivers			
GXB0 Transmit Channel	Transceiver channel	2	Minimize Trace Length (2.5 in.)
GXB0 Receive Channel	Transceiver channel	2	Minimize Trace Length (2.5 in.)
GXB2 Long Transmit Channel	Transceiver channel	2	33 in. Trace Length (8.5G)

Table 2-4. Stratix IV GX I/O Usage Summary (Part 3 of 3)

Function	I/O Type	I/O Count	Description
GXB2 Short Receive Channel	Transceiver channel	2	7 in. Trace Length (8.5G)
GXB1 6 Full Duplex Transceiver Channels (1 entire block)	Transceiver channel	24	4 Full Duplex channels from 1 entire transceiver block (2 from clock multiplier unit (CMU) block)
Spares			
Spare[7:0]	2.5V CMOS inout	8	Spare signals to MAX II CPLD
Device I/O Total: 208			
Stratix IV GX I/O Available: 736			

Configuration, Status, and Setup Elements

This section describes the board's configuration, status, and setup elements.

Configuration

The Stratix IV GX transceiver signal integrity development board supports three configuration methods:

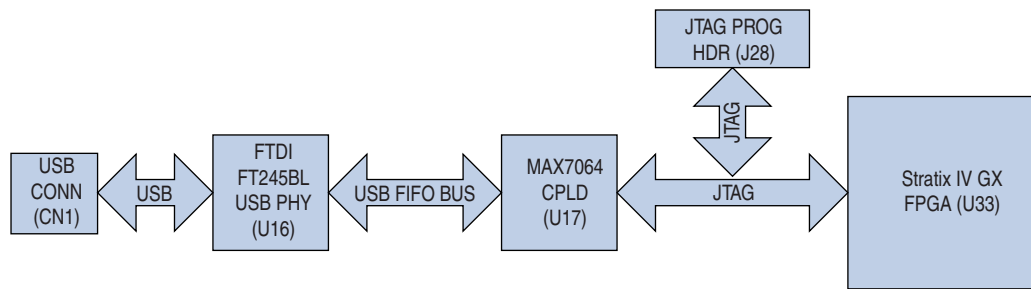
- Embedded USB-Blaster is the default method for configuring the FPGA at any time using the Quartus II Programmer in JTAG mode with the supplied USB cable.
- MAX II+Flash FPP download is used for configuring the FPGA using stored images from flash on either power-up or pressing the reset (SW8) push-button.
- JTAG programming header (J28) is used for configuring the FPGA using an external USB-Blaster (not supplied) and the Quartus II Programmer.

The following sections describe each of these methods.

Embedded USB-Blaster

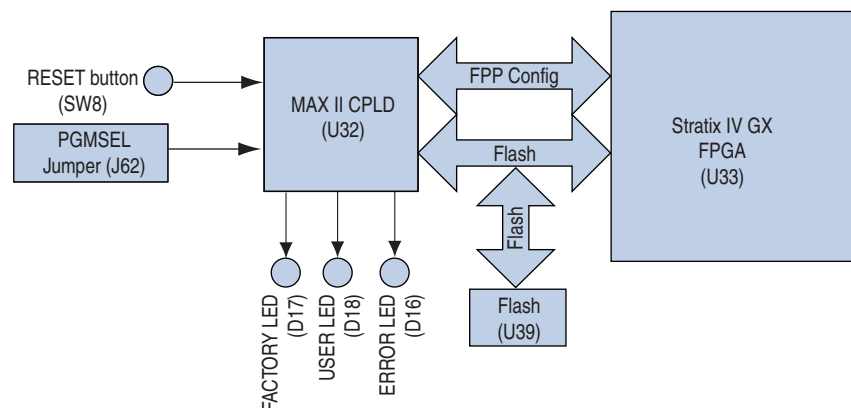
Figure 2-3 shows the block diagram for the embedded USB-Blaster. The USB-Blaster is implemented using a Type-B USB connector (CN1), a Future Technologies FT245BL USB PHY device (U16), and an Altera MAX7064 CPLD (U17). This allows the configuration of the FPGA using a USB cable directly connected between the USB port on the board (CN1) and a USB port of a PC running the Quartus II software.

A green Blaster LED (D7) is also provided to indicate USB-Blaster activity. The embedded USB-Blaster is automatically disabled when an external USB-Blaster is connected to the JTAG chain at connector J28.

Figure 2-3. Embedded USB-Blaster

Fast Passive Parallel Download

Figure 2-4 shows the block diagram for the MAX II+Flash FPP configuration. This method is used for automatic configuration of the FPGA upon board power-up or reset with the configuration programming image stored in flash memory. The FPP download controller is implemented within an Altera MAX II EPM1270F256C3N CPLD (U32). This controller, together with the Numonyx PC48F4400P0VB00 512-Mbit CFI NOR-type flash device (U39), performs the FPP configuration upon board power-up or reset. The CPLD shares the Flash interface with the FPGA. The PGMSEL jumper (J62) selects between two Programmer Object Files (.pof) files (factory or user) stored in the Flash. The FPP controller uses the Altera Parallel Flash Loader (PFL) megafunction to configure the FPGA by reading data from the flash and converting it to FPP format. This data is written to the FPGA's dedicated configuration pins during configuration. Configuration Mode Select signals MSEL[2:0] are pulled to [0, 0, 0] on the board for FPP mode configuration.

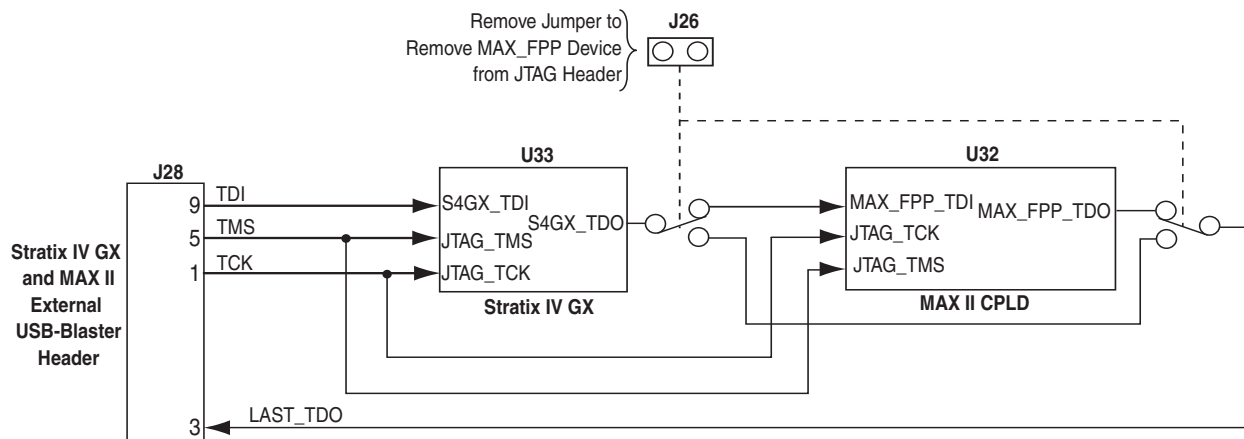
Figure 2-4. MAX II+Flash FPP Configuration

After a power-up or reset event, the MAX II CPLD automatically configures the FPGA in FPP mode with either the pre-installed factory .pof file or a user .pof file depending on the setting of the PGMSEL Jumper (J62). Additionally, three green LEDs (D16–D18) indicate the status of the FPP configuration.

JTAG Programming Header

Figure 2-5 shows the schematic connections for the dedicated JTAG programming header (J28). This header provides another method for configuring the FPGA (U33) using an Altera USB-Blaster with the Quartus II Programmer running on a PC. MAX II bypass jumper (J26) allows the MAX II CPLD device to be removed from the JTAG chain so that the FPGA is the only device on the JTAG chain.

Figure 2-5. JTAG Programming Header



Status and Setup Elements

The development board includes board-specific status LEDs, jumpers and switches used for enabling and configuring various features on the board, as well as a 16 character × 2 line LCD for displaying board power and temperature measurements. This section describes these status and setup elements.

Status LEDs

Table 2-5 lists the LED board references, names, and functional descriptions.

Table 2-5. Board-Specific LEDs (Part 1 of 2)

Board Reference	LED Name	Description
D3	POWER	Blue LED. Illuminates when board power switch (SW1) is on. (Requires 14–20 V input to DC input jack J1)
D6	FAN	Amber LED. Illuminates to indicate an FPGA over-temperature condition. A fan sink must be attached to the FPGA and running to prevent overheating.
D7	BLASTER	Green LED. Blinks to indicate the embedded USB-Blaster activity.
D16	ERROR	Red LED. Illuminates when a configuration error has occurred.
D17	FACTORY	Green LED. Illuminates when the factory POF image is successfully programmed into the FPGA.
D18	USER	Green LED. Illuminates when the user POF image is successfully programmed into the FPGA.
D19	TX	Green LED. Blinks to indicate Ethernet transmit activity.
D20	RX	Green LED. Blinks to indicate Ethernet receive activity.

Table 2-5. Board-Specific LEDs (Part 2 of 2)

Board Reference	LED Name	Description
D21	DUPLEX	Green LED. Illuminates to indicate Ethernet full duplex status.
D22	1000	Green LED. Illuminates to indicate Ethernet linked at 1000 Mbps.
D23	100	Green LED. Illuminates to indicate Ethernet linked at 100 Mbps.
D24	10	Green LED. Illuminates to indicate Ethernet linked at 10 Mbps.

Surface mount LEDs indicate the various status of the board as shown in [Table 2-6](#).

Table 2-6. Status LEDs

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Number	Other Connections
D3	Power LED	5V	N/A	N/A	N/A
D17	FACTORY LED	FACTORY_IMAGE	2.5V CMOS	N/A	U32 pin R8
D18	USER LED	USER_IMAGE	2.5V CMOS	N/A	U32 pin R7
D16	ERROR LED	CONFIG_ERR	2.5V CMOS	N/A	U32 pin R9
D19	Ethernet transmit activity LED	ENET_LED_TX	2.5V CMOS	N/A	U40 pin 68
D20	Ethernet receive activity LED	ENET_LED_RX	2.5V CMOS	N/A	U40 pin 69
D21	Ethernet Full-Duplex LED	ENET_LED_DUPLEX	2.5V CMOS	N/A	U40 pin 70
D22	Ethernet 1000-MB Link LED	ENET_LED_LINK1000	2.5V CMOS	N/A	U40 pin 73
D23	Ethernet 100-MB Link LED	ENET_LED_LINK100	2.5V CMOS	N/A	U40 pin 74
D24	Ethernet 100-MB Link LED	ENET_LED_LINK10	2.5V CMOS	N/A	U40 pin 76
D6	Over-temperature LED	FAN_LED	2.5V CMOS	U33 pin F14	N/A
D7	USB-Blaster activity LED	USB_LED	3.3V CMOS	N/A	U17 pin 8

Board Jumpers

[Table 2-7](#) lists the board jumper references, names, and functional descriptions.

Table 2-7. Board Jumpers (Part 1 of 2)

Board Reference	Jumper Name	Description
J6	VCCA_SEL	When a jumper is installed on pins 1-2, VCCA is set to 2.5 V. When a jumper is installed on pins 2-3, VCCA is set to 3.0 V
J11	VCCH_SEL	When a jumper is installed on pins 1-2, VCCH is set to 1.4 V. When a jumper is installed on pins 2-3, VCCH is set to 1.5 V
J26	MAXII BYPASS	When a jumper is installed, the MAX II CPLD device (U32) is included in the JTAG programming chain. When a jumper is removed, the MAX II CPLD device (U32) is removed from the JTAG programming chain.
J62	PGMSEL	When a jumper is installed on pins 1-2, FPP configuration loads the user POF image from flash. When a jumper is installed on pins 2-3, FPP configuration loads the factory POF image from flash.

Table 2-7. Board Jumpers (Part 2 of 2)

Board Reference	Jumper Name	Description
J64	FAN	When a jumper is installed on pins 1-2, the fan is automatically controlled by the FPGA. When a jumper is installed on pins 2-3, the fan is always on.
J65	Y3 OSC EN/DIS	When a jumper is installed, Y3 oscillator is disabled. When a jumper is removed, Y3 oscillator is enabled and running.
J66	Y4 OSC EN/DIS	When a jumper is installed, Y4 oscillator is disabled. When a jumper is removed, Y4 oscillator is enabled and running.
J67	Y5 OSC EN/DIS	When a jumper is installed, Y5 oscillator is disabled. When a jumper is removed, Y5 oscillator is enabled and running.

There is a mini-DIP switch (SW2) for configuring the spread spectrum clock device (U21). Table 2-8 lists the connection of the mini-DIP switch (SW2) while Table 2-9 summarizes its functionality.

Table 2-8. Mini-DIP Switch Pin-Out (SW2)

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Name	Other Connections
SW2 pin 1 (S0)	Spread spectrum clock configuration DIP switch. When the switch is in the open position, a logic 1 is selected. When the switch is in the closed position, a logic 0 is selected.	S0	2.5V CMOS	N/A	U21 pin 1
SW2 pin 2 (S1)		S1	2.5V CMOS	N/A	U21 pin 2
SW2 pin 3 (S2)		SS0	2.5V CMOS	N/A	U21 pin 3
SW2 pin 4 (S3)		SS1	2.5V CMOS	N/A	U21 pin 8

Table 2-9. Mini-DIP Switch Configuration (SW2)

S1	S0	Clock Frequency	S3	S2	Spread Spectrum %
0	0	25 MHz	0	0	Center ± 25
0	1	100 MHz	0	1	Down -0.50
1	0	125 MHz	1	0	Down -0.75
1	1	200 MHz	1	1	No spread spectrum

Clocks

Clocking for the Stratix IV GX transceiver signal integrity board is provided separately for both the FPGA core and transceivers. The core clocks include a dedicated 50-MHz clock, a spread spectrum clock capable of producing either 25-MHz, 100-MHz, 125-MHz, or 200-MHz clock, and a pair of SMA connectors to receive a differential external clock. The dedicated transceiver clocks include a 100-MHz, 156.25-MHz clock source, and a socket for accepting a 5×7-mm 6-pin oscillator. This socket has the flexibility of providing any custom oscillator frequency to the transceivers. Additionally, if an oscillator with the desired frequency is not readily available, the transceivers can receive a differential clock from an external source through a pair of SMA connectors.

Figure 2-6 shows the Stratix IV GX transceiver signal integrity development board clocking diagram.

Figure 2-6. Stratix IV GX Transceiver Signal Integrity Board Clocking Diagram

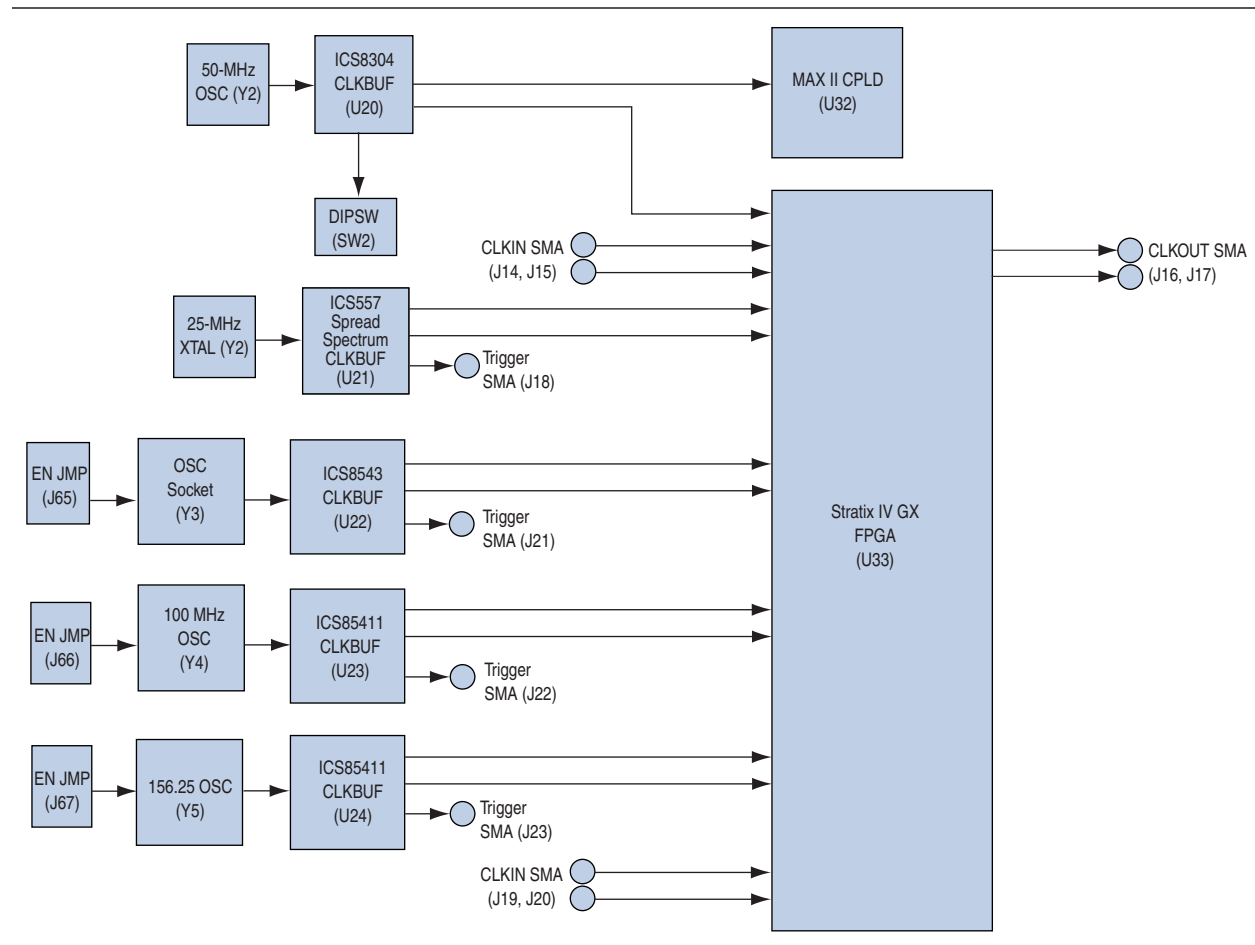


Table 2-10 shows the clock distribution for the Stratix IV GX transceiver signal integrity development board.

Table 2-10. Stratix IV GX Transceiver Signal Integrity Board Clock Distribution

Frequency	Signal Name	Signal Originates From	Signal Propagates To
50 MHz	MAXII_50M_CLK S4GX_50M_CLK4P	U20 pin 8 U20 pin 7	U32 pin H5 U33 pin AR22
User Input	S4GX_EXT_CLK5P S4GX_EXT_CLK5N	SMA J14 SMA J15	U33 pin AV22 U33 pin AW22
User Defined	IO_CLKOUT1	U33 pin M20	SMA J16
User Defined	IO_CLKOUT2	U33 pin L20	SMA J17
25 MHz, 100 MHz, 125 MHz, 200 MHz (Y2) (Frequencies Set by Switch SW2)	S4GX_CLK1P S4GX_CLK1N	U21 pin 15 U21 pin 14	U33 pin AB34 U33 pin AA35
User Input	EXT_REFCLK0P_GXB0 EXT_REFCLK0N_GXB0	SMA J19 SMA J20	U33 pin AN38 U33 pin AN39
OSC Socket (Y3)	SKT_REFCLK1P_GXB0 155.52M_REFCLK1N_GXB0	U22 pin 20 U22 pin 19	U33 pin AL38 U33 pin AL39
156.25 MHz (Y5)	156.25M_REFCLK1P_GXB2 156.25M_REFCLK1N_GXB2	U24 pin 1 U24 pin 2	U33 pin G38 U33 pin G39
100 MHz (Y4)	100M_REFCLK0P_GXB2 100M_REFCLK0N_GXB2	U23 pin 1 U23 pin 2	U33 pin J38 U33 pin J39
25 MHz, 100 MHz, 125 MHz, 200 MHz	X2 Trigger	U21 pin 11	SMA J18
Socket (Y3)	Y3 Trigger	U22 pin 12	SMA J21
100 MHz (Y4)	Y4 Trigger	U23 pin 3	SMA J22
156.25 MHz (Y5)	Y5 Trigger	U24 pin 3	SMA J23

General User Input/Output

This section describes the user I/O interface to the FPGA including the push-buttons, user and status LEDs, LCD, and user DIP, rotary, and slide switches. [Table 2-11](#) lists the component references and the manufacturing information.

Table 2-11. Component Reference Input and Output Devices

Board Reference	Device Description	Manufacturer	Manufacturer Part Number	Manufacturer Website
SW3–SW6, SW8–SW15	Push-buttons	Panasonic Corporation	EVQPAC07K	www.panasonic.com
D7–D15, D17–D24	Green LEDs	Lumex Inc.	SML-LX1206GC-TR	www.lumex.com
D16	Red LED	Lumex Inc.	SML-LX1206IC-TR	www.lumex.com
D6	Amber LED	Lite-on Technology Corporation	LTST-C150KYKT	www.liteon.com
D3	Blue LED	Lumex Inc.	SML-LX1206USBC-TR	www.lumex.com
LCD	LCD	Lumex Inc.	LCM-S01602DSR/C	www.lumex.com
SW7	DIP switch	Grayhill Corporation	76SB08ST	www.grayhill.com
SW2	Mini-DIP switch	C&K Components / ITT Industries	TDA04H0SB1	www.ittcannon.com
SW16	Rotary switch	Grayhill Corporation	94HCB16WT	www.grayhill.com
SW1	Slide switch	E-switch Inc.	EG2201A	www.e-switch.com

Push-Button Switches

The board has 12 push-button switches for user-defined logic input. Each push-button when pressed drives logic low and when released returns to driving logic high.

[Table 2-12](#) summarizes these push-button switches.

Table 2-12. Push-Button Switch Signal Names and Functions

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Number	Other Connections
SW10	General purpose user push-button switches. These switches are not debounced.	USR_PB0	2.5V CMOS	U33 pin AW28	10-k Ω pull-up resistor to 2.5 V
SW11		USR_PB1		U33 pin AV28	
SW12		USR_PB2		U33 pin AU28	
SW13		USR_PB3		U33 pin AT28	
SW14		USR_PB4		U33 pin AR28	
SW15		USR_PB5		U33 pin AP28	
SW8	Board reset. These switches are not debounced.	RESETn	2.5V CMOS	N/A	U32 pin T2
SW9	CPU reset. These switches are not debounced.	CPURSTn		U33 pin AW18	10-k Ω pull-up resistor to 2.5 V
SW3	LCD menu directional push-buttons switches. These switches are not debounced.	BACK		U33 pin G21	10-k Ω pull-up resistor to 2.5 V
SW4		ENTR		U33 pin G23	
SW5		UP		U33 pin G22	
SW6		DWN		U33 pin H22	

User LEDs

A bank of eight green, surface mount LEDs (SM1206 type) are provided for general purpose use. The cathodes of these LEDs are each connected to an FPGA I/O pin while the anodes are pulled to 2.5 V through a current limiting resistor. Driving the corresponding FPGA I/O pin low illuminates the LED. Driving it high turns the LED off. [Table 2-13](#) lists the assignment for each user LED.

Table 2-13. User LED Pin-Out (Green)

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Number	Other Connections
D8	General Purpose green surface mount (type 1206) User LEDs. Driving a logic 0 on the I/O port turns the LED ON. Driving a logic 1 on the I/O port turns the LED OFF.	USR_LED0	2.5V CMOS	U33 pin AW29	160 Ω to 2.5 V
D9		USR_LED1	2.5V CMOS	U33 pin AV29	160 Ω to 2.5 V
D10		USR_LED2	2.5V CMOS	U33 pin AU29	160 Ω to 2.5 V
D11		USR_LED3	2.5V CMOS	U33 pin AT29	160 Ω to 2.5 V
D12		USR_LED4	2.5V CMOS	U33 pin AW30	160 Ω to 2.5 V
D13		USR_LED5	2.5V CMOS	U33 pin AT30	160 Ω to 2.5 V
D14		USR_LED6	2.5V CMOS	U33 pin AP30	160 Ω to 2.5 V
D15		USR_LED7	2.5V CMOS	U33 pin AN30	160 Ω to 2.5 V

LCD

A 16 character × 2 line LCD is provided. The display is directly connected to the FPGA device. Table 2-14 shows the LCD pin assignments.

Table 2-14. Seven-Segment Display Pin-Out

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Name	Other Connections
LCD	LCD DATA 0	LCD_DATA0	2.5V CMOS	U33 pin B17	J24 pin 7
LCD	LCD DATA 1	LCD_DATA1	2.5V CMOS	U33 pin B19	J24 pin 8
LCD	LCD DATA 2	LCD_DATA2	2.5V CMOS	U33 pin D21	J24 pin 9
LCD	LCD DATA 3	LCD_DATA3	2.5V CMOS	U33 pin D22	J24 pin 10
LCD	LCD DATA 4	LCD_DATA4	2.5V CMOS	U33 pin D23	J24 pin 11
LCD	LCD DATA 5	LCD_DATA5	2.5V CMOS	U33 pin E22	J24 pin 12
LCD	LCD DATA 6	LCD_DATA6	2.5V CMOS	U33 pin E23	J24 pin 13
LCD	LCD DATA 7	LCD_DATA7	2.5V CMOS	U33 pin F23	J24 pin 14
LCD	LCD ENABLE Signal	LCD_EN	2.5V CMOS	U33 pin C22	J24 pin 6
LCD	LCD DATA/CONTROL Signal	LCD_D_Cn	2.5V CMOS	U33 pin A18	J24 pin 4
LCD	LCD Write Enable Strobe	LCD_Wen	2.5V CMOS	U33 pin A17	J24 pin 5

DIP Switches

The user DIP switch is for reference design functions and general purpose use. This switch is connected to the FPGA device I/O pins. Table 2-15 summarizes the function and connections of the DIP switch (SW7).

Table 2-15. User DIP Switch Pin-Out (SW7)

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Name	Other Connections
SW7 pin 1	User DIP switch connected to FPGA device. When the switch is in the open position, a logic 1 is selected. When the switch is in the closed position, a logic 0 is selected.	USR_DIP0	2.5V CMOS	U33 pin AW27	10-kΩ pull-up resistor to 2.5 V
SW7 pin 2		USR_DIP1	2.5V CMOS	U33 pin AU27	
SW7 pin 3		USR_DIP2	2.5V CMOS	U33 pin AT27	
SW7 pin 4		USR_DIP3	2.5V CMOS	U33 pin AP27	
SW7 pin 5		USR_DIP4	2.5V CMOS	U33 pin AN27	
SW7 pin 6		USR_DIP5	2.5V CMOS	U33 pin AP26	
SW7 pin 7		USR_DIP6	2.5V CMOS	U33 pin AN26	
SW7 pin 8		USR_DIP7	2.5V CMOS	U33 pin AM26	

Flash Memory Device

The board features a Numonyx PC48F4400P0VB00 512-Mbit CFI-compliant NOR-type flash memory device. This device is used to store configuration files for the FPGA. Both MAX II CPLD (U32) and FPGA (U33) devices can access the flash. MAXII accesses are for FPP configuration of the FPGA using the PFL Megafunction. FPGA access to the flash's user space is provided for embedded NIOS applications.

Table 2-16 provides the pin-out information of the flash memory interface to the FPGA. The signal direction is with respect to the FPGA device.

Table 2-16. Flash Memory Pin-Out (SW1) (Part 1 of 2)

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Name	Other Connections
U39 pin A1	Flash Address bus bit 1	F_AD1	2.5V CMOS	U33 pin AN15	U32 pin M16
U39 pin B1	Flash Address bus bit 2	F_AD2	2.5V CMOS	U33 pin AM14	U32 pin M15
U39 pin C1	Flash Address bus bit 3	F_AD3	2.5V CMOS	U33 pin AN14	U32 pin M14
U39 pin D1	Flash Address bus bit 4	F_AD4	2.5V CMOS	U33 pin AP15	U32 pin N16
U39 pin D2	Flash Address bus bit 5	F_AD5	2.5V CMOS	U33 pin AP14	U32 pin N15
U39 pin A2	Flash Address bus bit 6	F_AD6	2.5V CMOS	U33 pin AL15	U32 pin J16
U39 pin C2	Flash Address bus bit 7	F_AD7	2.5V CMOS	U33 pin AP13	U32 pin N13
U39 pin A3	Flash Address bus bit 8	F_AD8	2.5V CMOS	U33 pin AN13	U32 pin N14
U39 pin B3	Flash Address bus bit 9	F_AD9	2.5V CMOS	U33 pin J15	U32 pin C14
U39 pin C3	Flash Address bus bit 10	F_AD10	2.5V CMOS	U33 pin H13	U32 pin B12
U39 pin D3	Flash Address bus bit 11	F_AD11	2.5V CMOS	U33 pin M13	U32 pin F15
U39 pin C4	Flash Address bus bit 12	F_AD12	2.5V CMOS	U33 pin M14	U32 pin F16
U39 pin A5	Flash Address bus bit 13	F_AD13	2.5V CMOS	U33 pin K15	U32 pin D16
U39 pin B5	Flash Address bus bit 14	F_AD14	2.5V CMOS	U33 pin G13	U32 pin A11
U39 pin C5	Flash Address bus bit 15	F_AD15	2.5V CMOS	U33 pin G14	U32 pin A12
U39 pin D7	Flash Address bus bit 16	F_AD16	2.5V CMOS	U33 pin J12	U32 pin B13
U39 pin D8	Flash Address bus bit 17	F_AD17	2.5V CMOS	U33 pin L13	U32 pin E15
U39 pin A7	Flash Address bus bit 18	F_AD18	2.5V CMOS	U33 pin AM13	U32 pin L14
U39 pin B7	Flash Address bus bit 19	F_AD19	2.5V CMOS	U33 pin AL14	U32 pin J15
U39 pin C7	Flash Address bus bit 20	F_AD20	2.5V CMOS	U33 pin K13	U32 pin D14
U39 pin C8	Flash Address bus bit 21	F_AD21	2.5V CMOS	U33 pin AL13	U32 pin K14
U39 pin A8	Flash Address bus bit 22	F_AD22	2.5V CMOS	U33 pin K14	U32 pin D15
U39 pin G1	Flash Address bus bit 23	F_AD23	2.5V CMOS	U33 pin H14	U32 pin A13
U39 pin H8	Flash Address bus bit 24	F_AD24	2.5V CMOS	U33 pin J13	U32 pin B14
U39 pin B6	Flash Address bus bit 25	F_AD25	2.5V CMOS	U33 pin K12	U32 pin C13
U39 pin F2	Flash Data bus bit 0	F_D0	2.5V CMOS	U33 pin AK13	U32 pin L15
U39 pin E2	Flash Data bus bit 1	F_D1	2.5V CMOS	U33 pin AK14	U32 pin L16
U39 pin G3	Flash Data bus bit 2	F_D2	2.5V CMOS	U33 pin AJ13	U32 pin K15
U39 pin E4	Flash Data bus bit 3	F_D3	2.5V CMOS	U33 pin AJ14	U32 pin K16
U39 pin E5	Flash Data bus bit 4	F_D4	2.5V CMOS	U33 pin AH14	U32 pin H16

Table 2-16. Flash Memory Pin-Out (SW1) (Part 2 of 2)

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Name	Other Connections
U39 pin G5	Flash Data bus bit 5	F_D5	2.5V CMOS	U33 pin AH13	U32 pin H15
U39 pin G6	Flash Data bus bit 6	F_D6	2.5V CMOS	U33 pin AG15	U32 pin G16
U39 pin H7	Flash Data bus bit 7	F_D7	2.5V CMOS	U33 pin AG14	U32 pin G15
U39 pin E1	Flash Data bus bit 8	F_D8	2.5V CMOS	U33 pin AE15	U32 pin M13
U39 pin E3	Flash Data bus bit 9	F_D9	2.5V CMOS	U33 pin AD15	U32 pin L13
U39 pin F3	Flash Data bus bit 10	F_D10	2.5V CMOS	U33 pin AF16	U32 pin J13
U39 pin F4	Flash Data bus bit 11	F_D11	2.5V CMOS	U33 pin AE16	U32 pin H13
U39 pin F5	Flash Data bus bit 12	F_D12	2.5V CMOS	U33 pin AG18	U32 pin G13
U39 pin H5	Flash Data bus bit 13	F_D13	2.5V CMOS	U33 pin AE18	U32 pin F13
U39 pin G7	Flash Data bus bit 14	F_D14	2.5V CMOS	U33 pin AG19	U32 pin F14
U39 pin E7	Flash Data bus bit 15	F_D15	2.5V CMOS	U33 pin AF19	U32 pin E14
U39 pin E6	Flash Clock	F_CLK	2.5V CMOS	U33 pin AU14	U32 pin R16
U39 pin D4	Flash Reset	F_RSTn	2.5V CMOS	U33 pin N15	U32 pin H14
U39 pin B4	Flash Chip Enable	F_CEn	2.5V CMOS	U33 pin AR13	U32 pin P14
U39 pin F8	Flash Output Enable	F_OEn	2.5V CMOS	U33 pin AR14	U32 pin P15
U39 pin G8	Flash Write Enable	F_Wen	2.5V CMOS	U33 pin N13	U32 pin G14
U39 pin F6	Flash Address Valid	F_ADVn	2.5V CMOS	U33 pin AT13	U32 pin P13
U39 pin C6	Flash Write Protect	F_WPn	2.5V CMOS	U33 pin AT14	U32 pin T12
U39 pin F7	Flash Busy	F_BSYn	2.5V CMOS	U33 pin R14	U32 pin J14

Table 2-17 shows the flash memory map storage for two FPGA bitstreams (factory and user) as well as 40 MBytes of reserved user space for storage of PFL configuration settings, software binaries, and other data relevant to the targeted FPGA design (that is, Nios applications). For the EP4SGX230KF40 FPGA device, each FPGA bitstream can be a maximum of 94.54 Mbits (less than 12 MBytes). Hence, the factory and user POF space is set at 12 MBytes.

Table 2-17. Flash Memory Map

Name	Address
Reserved (40 MB)	0x03FF-FFFF 0x0180-0000
USER (12 MB)	0x017F-FFFF 0x00C0-0000
FACTORY (12 MB)	0x00BF-FFFF 0x0000-0000

Table 2-18 lists the flash memory device component reference and manufacturing information.

Table 2-18. Flash Memory Device

Board Reference	Description	Manufacturer	Manufacturing Part Number	Manufacturer Website
U39	512-Mbit NOR-type Flash	Numonyx	PC48F4400P0VB00	www.numonyx.com

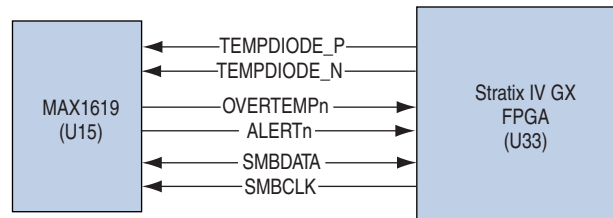
Components and Interfaces

This section describes the temperature measurement and power measurement circuitries and the board's communication ports.

Temperature Measurement

Figure 2-7 shows the block diagram for the temperature measurement circuitry.

Figure 2-7. Temperature Measurement



Temperature monitoring for the Stratix IV die is achieved by a MAX1619 temperature sense device. The MAX1619 is connected to the FPGA by a 2-wire SMBus interface. The OVERTEMPn and ALERTn signals from the MAX1619 are connected to the FPGA to allow it to immediately sense a temperature fault condition and turn on the attached fan. The fan is controlled by the FPGA, based on the OVERTEMPn signal from the MAX1619, or it can be set to ON always. Jumper J64 is used to configure the fan as shown in Table 2-19.

Table 2-19. Fan Jumper (J64)

Board Reference	Jumper Name	Description
J64	FAN	When a jumper is installed on pins 1-2, the fan is auto-controlled by the FPGA.
		When a jumper is installed on pins 2-3, the fan is always on.

An over-temperature orange warning LED (D6) is also connected to the FPGA to indicate that an over-temperature condition exists and that a fan should be attached and running. Table 2-20 provides the pin-out of the temperature sense interface to the FPGA.

Table 2-20. Temperature Sensor Pin-Out (Part 1 of 2)

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Number	Other Connections
U15 pin 3	Analog sense DIODE P pin	TEMPDIODE_P	Analog	U33 pin A9	—
U15 pin 4	Analog sense DIODE N pin	TEMPDIODE_N	Analog	U33 pin E11	—

Table 2-20. Temperature Sensor Pin-Out (Part 2 of 2)

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Number	Other Connections
U15 pin 12	SMBus Data pin	S4_SMBDATA	2.5V CMOS	U33 pin B14	10-k Ω pull-up resistor to 2.5 V
U15 pin 14	SMBus Clock pin	S4_SMBCLK	2.5V CMOS	U33 pin A14	10-k Ω pull-up resistor to 2.5 V
U15 pin 9	Over Temperature signal	OVERTEMPn	2.5V CMOS	U33 pin C14	10-k Ω pull-up resistor to 2.5 V
U15 pin 11	Alert signal	ALERTn	2.5V CMOS	U33 pin D14	10-k Ω pull-up resistor to 2.5 V

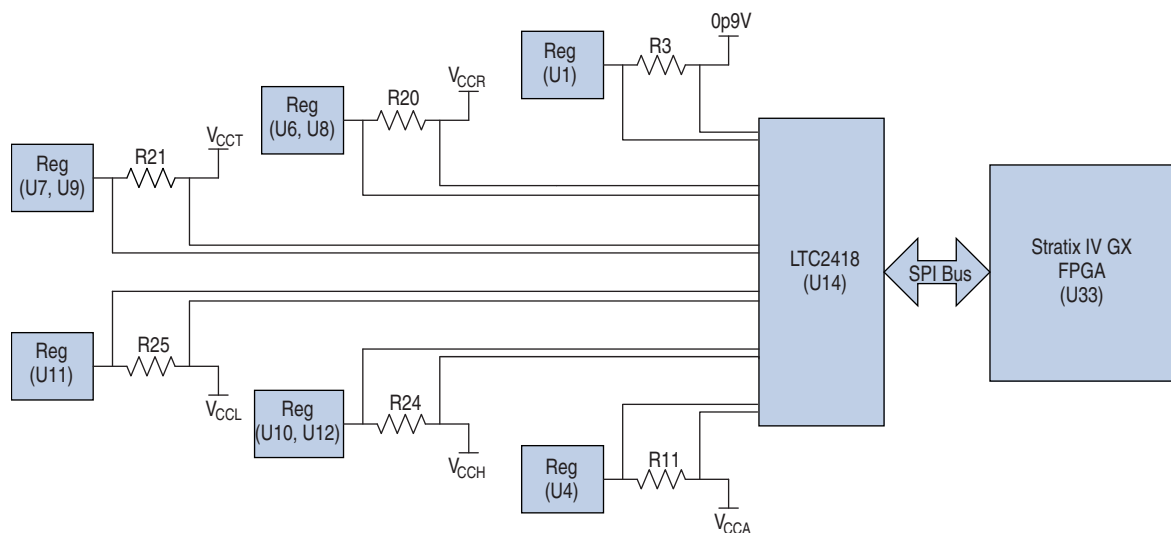
Table 2-21 lists the Temperature Sensor component reference and manufacturing information.

Table 2-21. Temperature Sensor Component Reference

Board Reference	Description	Manufacturer	Manufacturing Part Number	Manufacturer Website
U15	Dual Temperature Sensor with SMBus Interface	Maxim Integrated Products, Inc.	MAX1619MEE+T	www.maxim-ic.com

Power Measurement

Figure 2-8 shows the block diagram for the power measurement circuitry.

Figure 2-8. Power Measurement Circuit

Power measurement is provided for six FPGA power rails (0.9-V V_{CC} core plus the transceiver power rails— V_{CCR} , V_{CCT} , V_{CCL} , V_{CCH} , and V_{CCA}). Power measurement is implemented by a multi-channel differential 24-bit Linear Technology LT2418 (U14) delta-sigma analog-to-digital converter (ADC) and sense resistors to measure the small voltage drop across the resistors. This ADC is connected to the FPGA via a serial peripheral interface (SPI) bus. All power measurement processing and display to the LCD is handled by the FPGA. Selection of the specific power rail to be displayed on the LCD is controlled by a rotary switch (SW16). Table 2-22 lists the power rails being measured along with the value of the sense resistor used for each rail.

Table 2-22. Power Measurement Rails

Power Rail	Name Voltage (V)	Ref Des	Rsense (Ω)
V_{CC}	0.9	R3	0.001
V_{CCR}	1.1	R20	0.009
V_{CCT}	1.1	R21	0.009
V_{CCL}	1.1	R25	0.009
V_{CCH}	1.4 / 1.5	R24	0.009
V_{CCA}	2.5 / 3.0	R11	0.009

Table 2-23 shows the SPI Bus pin connections to the FPGA for the power measurement circuitry.

Table 2-23. Power Measurement Pin-Out

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Number	Other Connections
U14 pin 17	Serial Data Out	S4_SPI_MISO	2.5V CMOS	U33 pin C11	—
U14 pin 20	Serial Data In	S4_SPI_MOSI	2.5V CMOS	U33 pin B11	—
U14 pin 18	Serial Clock	S4_SPI_SCK	2.5V CMOS	U33 pin C12	—
U14 pin 16	Chip Select	S4_ADC_CS _n	2.5V CMOS	U33 pin C13	10-k Ω pull-up resistor to 2.5 V
U14 pin 19	Frequency Control	S4_ADC_F _o	2.5V CMOS	U33 pin A13	—

Table 2-24 lists the ADC component reference and manufacturing information.

Table 2-24. ADC Component Reference

Board Reference	Description	Manufacturer	Manufacturing Part Number	Manufacturer Website
U14	8-Channel differential 24-bit ADC	Linear Technology	LTC2418CGN#PBF	www.linear.com

Ethernet Port

The Stratix IV GX transceiver signal integrity development board incorporates a triple speed 10/100/1000 Base-T Ethernet port. The implementation uses a discrete Ethernet PHY device and RJ45 connector with integrated magnetics connected to the FPGA.

Figure 2-9 shows the block diagram of the Ethernet port.

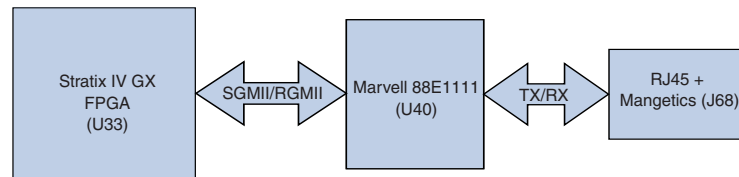
Figure 2-9. Ethernet Port

Table 2-25 lists the components used for the Ethernet port and the manufacturing information.

Table 2-25. Ethernet Component References

Board Reference	Description	Manufacturer	Manufacturing Part Number	Manufacturer Website
U40	10/100/1000 Base-T Ethernet PHY	Marvell Semiconductor	88E1111-B2-CAA1C000	www.marvell.com
J68	RJ45 with integrated Magnetics	Halo Electronics	HFJ11-1G02ERL	www.haloelectronics.com

Table 2-26 shows the SGMII and RGMII interface pin connection to the FPGA for the Ethernet PHY device.

Table 2-26. Power Measurement Pin-Out

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Number	Other Connections
U40 pin 11	RGMII Transmit Data 0	TXD0	2.5V CMOS	U33 pin C29	—
U40 pin 12	RGMII Transmit Data 1	TXD1	2.5V CMOS	U33 pin C30	—
U40 pin 14	RGMII Transmit Data 2	TXD2	2.5V CMOS	U33 pin A27	—
U40 pin 16	RGMII Transmit Data 3	TXD3	2.5V CMOS	U33 pin A29	—
U40 pin 9	RGMII Transmitter Enable	TXEN	2.5V CMOS	U33 pin A31	—
U40 pin 8	RGMII Transmit Clock	GTCLK	2.5V CMOS	U33 pin B29	—
U40 pin 95	RGMII Receive Data 0	RXD0	2.5V CMOS	U33 pin F27	—
U40 pin 92	RGMII Receive Data 1	RXD1	2.5V CMOS	U33 pin F26	—
U40 pin 93	RGMII Receive Data 2	RXD2	2.5V CMOS	U33 pin E29	—
U40 pin 91	RGMII Receive Data 3	RXD3	2.5V CMOS	U33 pin E28	—
U40 pin 94	RGMII Receive Data Valid	RXDV	2.5V CMOS	U33 pin D28	—
U40 pin 2	Receive Clock	RXCLK	2.5V CMOS	U33 pin D29	—
U40 pin 82	SGMII Transmit Data P	ENET_SGMII_TX_P	LVDS output	U33 pin L29	—
U40 pin 81	SGMII Transmit Data N	ENET_SGMII_TX_N	LVDS output	U33 pin K29	—
U40 pin 77	SGMII Receive Data P	ENET_SGMII_RX_P	LVDS input	U33 pin D31	—
U40 pin 75	SGMII Receive Data N	ENET_SGMII_RX_N	LVDS input	U33 pin C31	—

Transceiver Channels

The Stratix IV GX in the 1517-pin FBGA package incorporates six transceiver blocks (GXB0 Left/Right, GXB1 Left/Right, and GXB2 Left/Right), with up to six transmit and six receive channels per GXB block. For evaluation of these channels, this board offers a total of 16 transceiver channels of the three Left GXB blocks to SMA connectors. Table 2-27 shows the SMA connector information.

Table 2-27. SMA Connector Component References

Board Reference	Description	Manufacturer	Manufacturing Part Number	Manufacturer Website
J30–J61	SMA Connector	Lighthouse Technology	LTI-SASF546-P26-X1	www.maxim-ic.com

In the Left GXB0 block, one transmit and one receive channel are sent to SMA connectors J30, J32, J34 and J36. In the Left GXB1 block, all six transmit and six receive channels are sent to SMA connectors J38–J61. In the Left GXB2 block, one transmit and one receive channel are sent to SMA connectors J31, J33, J35 and J37.

Table 2-28 summarizes the transceiver channels available on the Stratix IV GX transceiver signal integrity development board.

Table 2-28. Transceiver Channel Pin-Out

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Number	Other Connections
J34, J36	Left GXB0 TX Channel	GXB0L_TX0 [p/n]	—	AT36, AT37	—
J30, J32	Left GXB0 RX Channel	GXB0L_RX0 [p/n]	—	AU38, AU39	—
J39, J41	TX1 from Left GXB1 Block	GXB1L_TX1 [p/n]	—	P36, P37	—
J38, J40	RX1 from Left GXB1 Block	GXB1L_RX1 [p/n]	—	R38, R39	—
J43, J45	TX2 from Left GXB1 Block	GXB1L_TX2 [p/n]	—	T36, T37	—
J42, J44	RX2 from Left GXB1 Block	GXB1L_RX2 [p/n]	—	U38, U39	—
J55, J57	TX3 from Left GXB1 Block	GXB1L_TX3 [p/n]	—	AB36, AB37	—
J54, J56	RX3 from Left GXB1 Block	GXB1L_RX3 [p/n]	—	AC38, AC39	—
J59, J61	TX4 from Left GXB1 Block	GXB1L_TX4 [p/n]	—	AD36, AD37	—
J58, J60	RX4 from Left GXB1 Block	GXB1L_RX4 [p/n]	—	AE38, AE39	—
J47, J49	TX5 from Left GXB1 Block	GXB1L_TX5 [p/n]	—	V36, V37	—
J46, J48	RX5 from Left GXB1 Block	GXB1L_RX5 [p/n]	—	W38, W39	—
J51, J53	TX6 from Left GXB1 Block	GXB1L_TX6 [p/n]	—	Y36, Y37	—
J50, J52	RX6 from Left GXB1 Block	GXB1L_RX6 [p/n]	—	AA38, AA39	—
J31, J33	33 in. long transmitter channel from Left GXB2 Block	GXB2L_TX7 [p/n]	—	B36, B37	—
J35, J37	7 in. long receiver channel from Left GXB2 Block	GXB2L_RX7 [p/n]	—	C38, C39	—

All receive channels include a 0402 type 0.1μF DC blocking capacitor in series with the P and N signals to remove the DC component of the transmitted signal. The receivers internally regenerate the required DC offset. Blocking capacitors are not provided for transmit channels.

Power

The board's power is provided through a laptop style DC power input. The input voltage must be in the range of 14 V to 20 V. The DC voltage is then stepped down to the various power rails used by the components on the board.

Power Switch

The slide switch (SW1) is the board power switch. When the slide switch is in the ON position, the board is powered on. When it is in the OFF position, the board is powered off. Table 2-29 shows the connection of this power switch.

Table 2-29. Slide Pin-Out (SW1)

Board Reference	Description	Schematic Signal Name	I/O Standard	Stratix IV GX Device Pin Name	Other Connections
SW1	Power Switch. Slide switch to ON position to power on the board. Slide switch to OFF position to power off the board.	RUN_SW	N/A	N/A	DC Input U1 pin A10 U2 pin A10 U3 pin A10

Power Distribution System

Figure 2-10 shows the power distribution system on the board. Table 2-30 lists the power components used on the board.

Figure 2-10. Power Distribution System

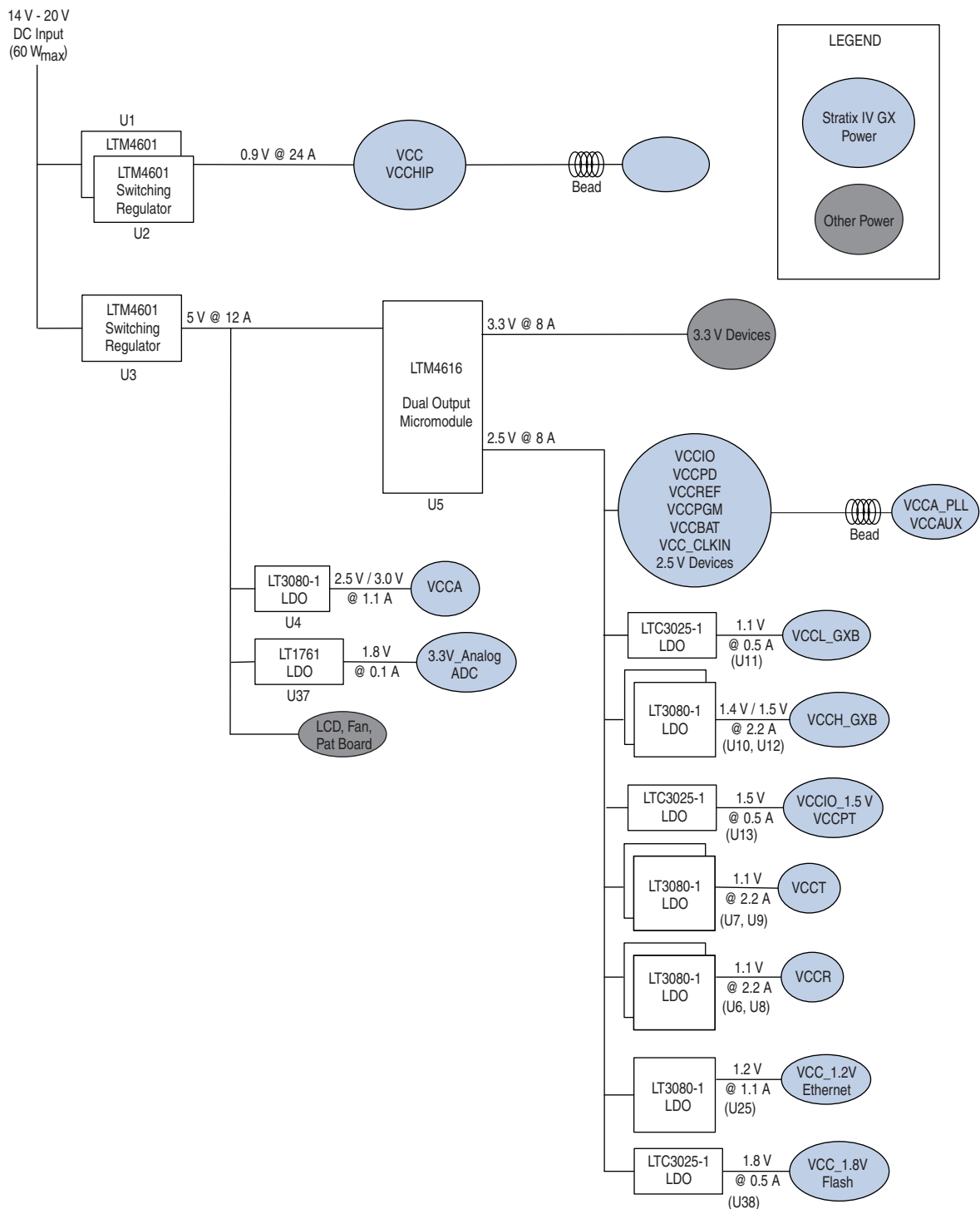


Table 2-30. Voltage Regulator Component Reference

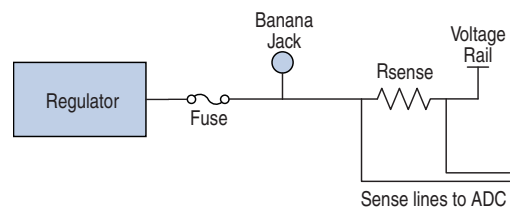
Reference Designator	Device Description	Manufacturer	Manufacturer Part Number	Manufacturer Website
U1, U2, U3	12A μ Module Switching Regulator	Linear Technology	LTM4601EV#PBF	www.linear.com
U5	Dual 8A/Channel μ Module Switching Regulator	Linear Technology	LTM4616EV#PBF	www.linear.com
U4, U6, U7, U8, U9, U10, U12, U25	1.1A LDO Linear Regulator	Linear Technology	LT3080EDD-1#PBF	www.linear.com
U11, U13, U38	500mA VLDO Linear Regulator	Linear Technology	LTC3025EDC-1#PBF	www.linear.com
U37	100mA Low Noise LDO Linear Regulator	Linear Technology	LT1761ES5-SD#PBF	www.linear.com

Banana Jacks and Fuses

In addition to the power supplied by the regulators, several power rails can be directly supplied by an external bench-top power supply through the on-board banana jacks (J2–J4, J7–J10). [Figure 2-11](#) illustrates how external power is allowed in through the banana jacks by first removing the fuses (F1–F7) associated with the power rail to be externally supplied.



Failure to remove the associated fuses (F1–F7) or improperly setting the external supply voltages too high can result in damage to the board.

Figure 2-11. External Power Supplied through Banana Jack

[Table 2-31](#) summarizes the banana jacks and fuses associated with each power rail that can be supplied by external power.

Table 2-31. Banana Jack and Fuses Component Reference (Part 1 of 2)

Banana Jack Board Reference	Fuse Board Reference	Device Description	Manufacturer	Manufacturer Part Number	Manufacturer Website
J2	F1, F2	Banana Jack and fuse for supplying external power to VCC core	Johnson Components	111-0702-001	www.johnsoncomponents.com
			Littelfuse Inc.	154 010.DR	www.littelfuse.com
J3	F3	Banana Jack and fuse for supplying external power to VCCA	Johnson Components	111-0702-001	www.johnsoncomponents.com
			Littelfuse Inc.	154 002	www.littelfuse.com

Table 2-31. Banana Jack and Fuses Component Reference (Part 2 of 2)

Banana Jack Board Reference	Fuse Board Reference	Device Description	Manufacturer	Manufacturer Part Number	Manufacturer Website
J9	F6	Banana Jack and fuse for supplying external power to VCCH	Johnson Components	111-0702-001	www.johnsoncomponents.com
			Littelfuse Inc.	154 005.DR	www.littelfuse.com
J10	F7	Banana Jack and fuse for supplying external power to VCCL	Johnson Components	111-0702-001	www.johnsoncomponents.com
			Littelfuse Inc.	154 002	www.littelfuse.com
J7	F4	Banana Jack and fuse for supplying external power to VCCR	Johnson Components	111-0702-001	www.johnsoncomponents.com
			Littelfuse Inc.	154 002	www.littelfuse.com
J8	F5	Banana Jack and fuse for supplying external power to VCCT	Johnson Components	111-0702-001	www.johnsoncomponents.com
			Littelfuse Inc.	154 002	www.littelfuse.com
J4, J5	N/A	Banana Jack connected to board GND	Johnson Components	111-0703-001	www.johnsoncomponents.com
			Littelfuse Inc.	N/A	www.littelfuse.com

Revision History

The following table displays the revision history for this reference manual.

Date	Version	Changes Made
February 2009	1.0	First publication

How to Contact Altera

For the most up-to-date information about Altera products, refer to the following table.






Contact <i>(Note 1)</i>	Contact Method	Address
Technical support	Website	www.altera.com/support
Technical training	Website	www.altera.com/training
	Email	custrain@altera.com
Product literature	Website	www.altera.com/literature
Non-technical support (General) (Software Licensing)	Email	nacomp@altera.com
	Email	authorization@altera.com

Note to Table:

(1) You can also contact your local Altera sales office or sales representative.

Typographic Conventions

This document uses the typographic conventions shown in the following table.

Visual Cue	Meaning
Bold Type with Initial Capital Letters	Indicates command names, dialog box titles, dialog box options, and other GUI labels. For example, Save As dialog box.
bold type	Indicates directory names, project names, disk drive names, file names, file name extensions, and software utility names. For example, \qdesigns directory, d: drive, and chiptrip.gdf file.
<i>Italic Type with Initial Capital Letters</i>	Indicates document titles. For example, <i>AN 519: Stratix IV Design Guidelines</i> .
<i>Italic type</i>	Indicates variables. For example, $n + 1$. Variable names are enclosed in angle brackets (<>). For example, <file name> and <project name>.pof file.
Initial Capital Letters	Indicates keyboard keys and menu names. For example, Delete key and the Options menu.
"Subheading Title"	Quotation marks indicate references to sections within a document and titles of Quartus II Help topics. For example, "Typographic Conventions."
Courier type	Indicates signal, port, register, bit, block, and primitive names. For example, data1, tdi, and input. Active-low signals are denoted by suffix n. For example, resetn. Indicates command line commands and anything that must be typed exactly as it appears. For example, c:\qdesigns\tutorial\chiptrip.gdf. Also indicates sections of an actual file, such as a Report File, references to parts of files (for example, the AHDL keyword SUBDESIGN), and logic function names (for example, TRI).
1., 2., 3., and a., b., c., and so on.	Numbered steps indicate a list of items when the sequence of the items is important, such as the steps listed in a procedure.
■ ■	Bullets indicate a list of items when the sequence of the items is not important.
	The hand points to information that requires special attention.
	A caution calls attention to a condition or possible situation that can damage or destroy the product or your work.
	A warning calls attention to a condition or possible situation that can cause you injury.
	The angled arrow instructs you to press Enter.
	The feet direct you to more information about a particular topic.